

View Online at https://aerobasegroup.com/nsn/5910-01-330-0474

Body Style:
Body Style: Chip type
Reliability Indicator: Established
Reliability Failure Rate Level In Percent:
Terminal Length:
Between 0.3 millimeters and 0.7 millimeters
Body Length:
2.0 millimeters
Body Width:
1.3 millimeters
Body Height:
1.3 millimeters
Center To Center Distance Between Terminals Parallel To Length:
0.5 millimeters
Schematic Diagram Designator:
No common or grounded electrode (s)
Insulation Resistance At Maximum Operating Temp:
10000.0 megohms
Capacitance Value Per Section:
4.300 picofarads single section
Nonderated Operating Temp:
Between -55.0 degrees celsius and 125.0 degrees celsius
Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:
0.0 single section
Nonderated Continuous Voltage Rating And Type Per Section:
100.0 dc single section
Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:
-30.0/+30.0 single section
Tolerance Range Per Section:
-0.10/+0.10 picofarads single section
Case Material:
Ceramic
Insulation Resistance At Reference Temp:
100000.0 megohms
Dissipation Factor At Reference Tempurature In Percent:
0.150
Terminal Surface Treatment:
Palladium and silver
Precious Material And Location:
Terminal surfaces palladium and terminal surfaces silver



Test Data Document:

81349-mil-c-55681 specification (includes engineering type bulletins, brochures, etc., that reflect specification type data in specification format; excludes commercial catalogs, industry directories, and similar trade publications, reflecting general type data on certain environmental and performance requirements and test conditions that are shown as "typical", "average", "", etc.).
Terminal Type And Quantity:
2 bonding pad
Specification Data:
81349-mil-c-55681/7 government specification
Shelf Life:
N/a
Unit Of Measure:
-Demilitarization:
No
Fiig:
A010b0